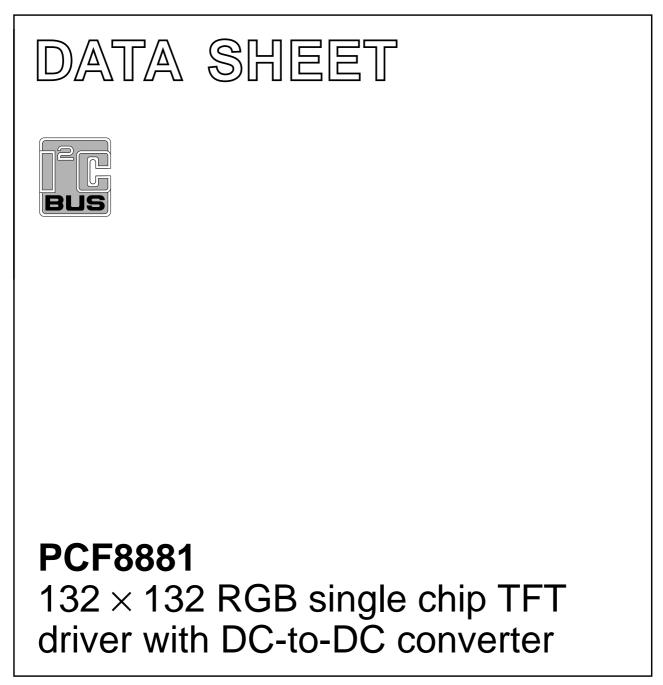
INTEGRATED CIRCUITS



Objective specification

2004 Aug 10









PCF8881

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PCF8881

1 GENERAL DESCRIPTION

The PCF8881 is a low-power single chip TFT LCD driver with integrated source driver, gate driver, display RAM, timing control and DC-to-DC converter. The IC is a single chip solution with a minimum number of external components (capacitors).

The PCF8881 has 396 source and 132 gate outputs ($132 \times RGB$ Sources \times 132 Gates). The integrated display RAM has a capacity of 279 kbits

(132 Sources \times 16 bits \times 132 Gates). The PCF8881 can drive a 132 RGB column \times 132 line LCD panel with 65 kbyte colours when using the internal RAM.

2 FEATURES

- Low-power single chip Thin Film Transistor (TFT) LCD driver with integrated source driver, gate driver, display RAM, timing controller and DC-to-DC converter
- 528 outputs (132 × 132 RGB)
- 132 gate driver with up to 25 V output level
- Gate driver features:
 - Integrated programmable voltage generator for 2 gate levels (max. 25 V)
 - programmable scan direction for different glass routing
 - special driving modes (interlace, dancing).
- Integrated voltage generator for source driver (4.8 V max., -4.8 V min.)
- On-chip $132 \times 132 \times 16$ -bit display data RAM for 65 kbyte colours
- · On-chip oscillator and timing controller
- On-chip common electrode voltage generator



- 4 predefined grey-level curves according to 4 gamma values
- Programmable grey-level curve with 2 × 16 externally available tab pins
- Integrated temperature compensation
- Display features:
 - Programmable frame refresh rate between 5 Hz and 85 Hz in 5 Hz steps
 - User selectable line or frame inversion
 - All pixels on/off modes
 - 8, 256, 4 k, and 65 k colour modes from look-up table (LUT).
- Interfaces:
 - 8-bit parallel interface (Intel 8080 and Motorola 68xx) with 16, 12 and 8-bpp resolution
 - extended 16-bit parallel interface (Intel 8080 or Motorola 68xx)
 - 3-line serial (9 bits per word).
- Digital power supply: 1.65 V to 1.95 V
- Analog power supply: 2.6 V to 2.9 V
- All driver settings are stored using a One Time Programming (OTP) block
- Slim chip layout, suitable for Chip-On-Glass (COG)
- Output staggered with 35 μm pitch.

3 ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
PCF8881U/2DA/1	_	chip with bumps in tray	

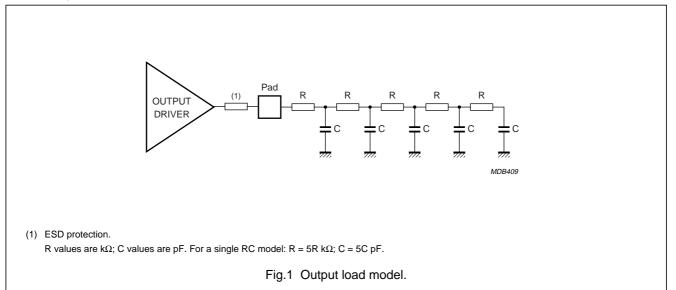
PCF8881

4 QUICK REFERENCE DATA

 $V_{DDD} = 2.7 \text{ V to } 3.3 \text{ V}; V_{DDA} = 2.7 \text{ V to } 3.3 \text{ V}; V_{SSD} = V_{SSA} = 0 \text{ V}; T_{amb} = -40 \text{ °C to } +70 \text{ °C}; f_{osc} = 227.8 \text{ kHz}; \text{ data} = 00\text{h}.$

SYMBOL	PARAMETER	CONDITION	MIN.	TYP.	MAX.	UNIT
Supplies						
V _{DDD}	logic supply voltage range		1.65	1.8	1.95	V
V _{DDA}	analog supply voltage range 2.6		2.75	2.9	V	
V _{SSD}	logic ground level 0.0			V		
V _{SSA}	analog ground level			0.0		V
Logic Inpu	uts				•	•
VIH	HIGH level input voltage		0.7V _{SSD}		V _{DDD}	V
V _{IL}	LOW level input voltage		0		0.3V _{DDD}	V
IL	input leakage current	$V_{I} = V_{DDD}$ or V_{SSD}	-1		+1	μA
Logic Out	puts		·	•	•	•
V _{OH}	HIGH level output voltage	current = 1 mA	0.8V _{DDD}		V _{DDD}	V
V _{OL}	LOW level output voltage	current = 1 mA	V _{SSD}		0.2V _{SSD}	V
Current co	onsumption analog and logic		L.	•	·	•
Power-dov	wn					
I _{DDD}	logic current consumption			0	0	μA
I _{DDA}	analog current consumption			10	20	μA

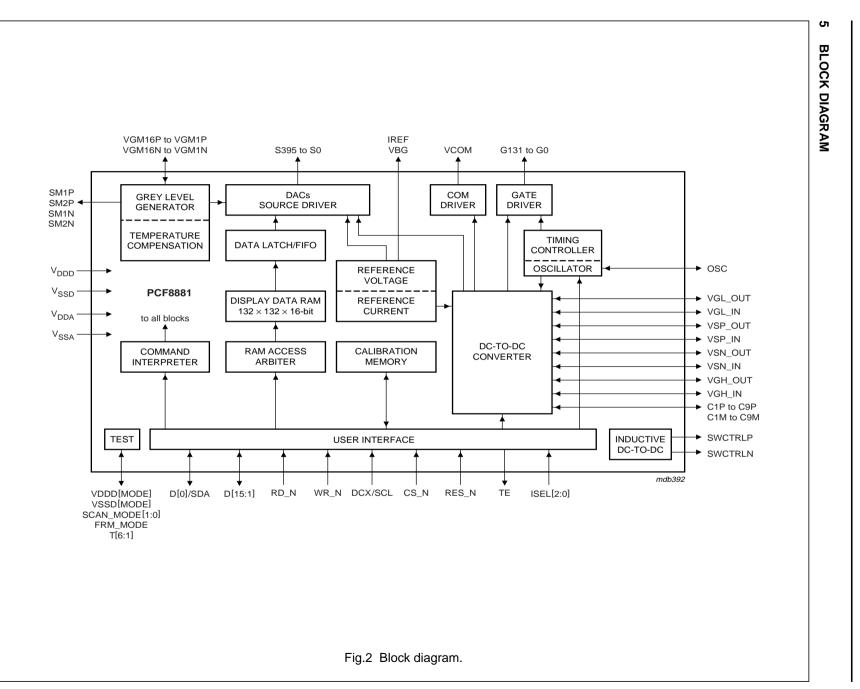
4.1 Output load model



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with 132 Х DC-to-DC **_** 132 RGB converter single chip Η Η driver



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6 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134); notes 1, 2 and 3.

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V _{DDD}	logic supply voltage	-0.5	+4.0	V
V _{DDA}	analog supply voltage	-0.5	+5.5	V
V _{GMA}	grey level reference voltage range	-0.5	+5.5	V
V _I / V _O	input / output voltage (any input / output)	-0.5	V _{DDD} + 0.5	V
I _I	DC input current	-10	+10	mA
I _O	DC output current	-10	+10	mA
I _{VDDD} , I _{VDDA} ,	supply current	-50	+50	mA
I _{VSSD,} I _{VSSA}				
P _{tot(pack)}	total power dissipation per package	-	tbd	mW
P/out	power dissipation per output	-	tbd	mW
T _{stg}	storage temperature; note 4	-55	+125	°C
T _{oper}	operating temperature	-40	+85	°C

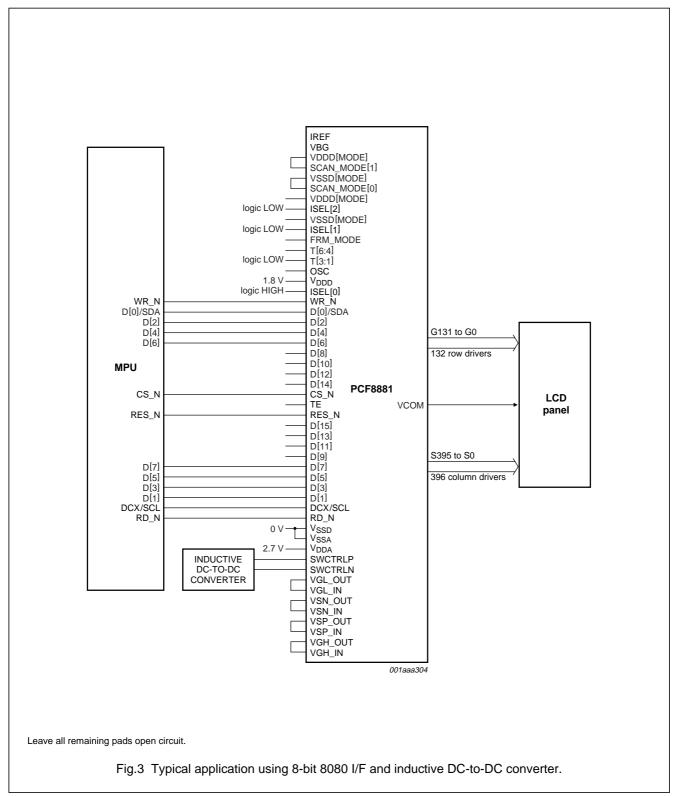
Note

- 1. Stresses above the given values will cause permanent damage to the device.
- 2. Parameters are valid over the operating temperature range unless otherwise specified.
- 3. All voltages are with respect to $V_{\mbox{\scriptsize SS}}$ unless otherwise specified.
- 4. The storage temperature specifies a safe temperature range for the chip when not powered.

7 HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However it is good practice to take normal precautions appropriate to handling MOS devices (see *"Handling MOS devices"*).

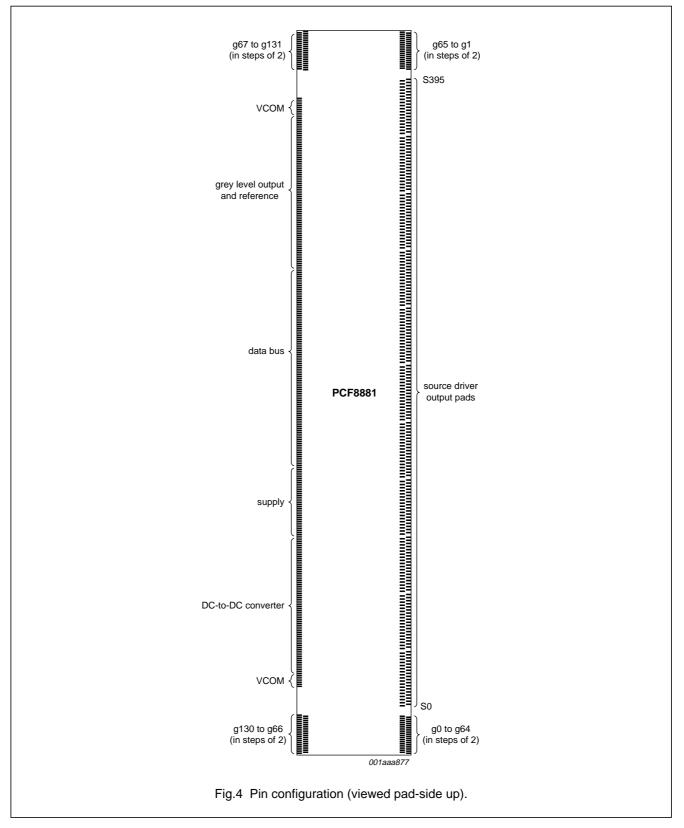
8 APPLICATION INFORMATION



PCF8881

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9 PIN CONFIGURATION



PCF8881

10 DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
11	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

11 DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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12 DISCLAIMERS

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PCF8881

13 PURCHASE OF PHILIPS I²C COMPONENTS



Purchase of Philips I²C components conveys a license under the Philips' I²C patent to use the components in the I²C system provided the system conforms to the I²C specification defined by Philips. This specification can be ordered using the code 9398 393 40011.

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Contact information

For additional information please visit http://www.semiconductors.philips.com. Fax: +31 40 27 24825 For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

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